

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6908548

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SCOTT BRAD HERNER	12/18/2018
ELI HARARI	09/25/2018
RECEIVING PARTY DATA	
Name:	SUNRISE MEMORY CORPORATION
Street Address:	225 CHARCOT AVENUE
City:	SAN JOSE
State/Country:	CALIFORNIA
Postal Code:	95131
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17470861
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	4086205501
Email:	patents@vlpawgroup.com
Correspondent Name:	VLP LAW GROUP, LLP
Address Line 1:	555 BRYANT STREET SUITE 820
Address Line 4:	PALO ALTO, CALIFORNIA 94301
ATTORNEY DOCKET NUMBER:	SRM-017 US C1
NAME OF SUBMITTER:	ANGELA WENDEL
SIGNATURE:	/angela wendel/
DATE SIGNED:	09/09/2021
Total Attachments: 2	
source=20210909_SRM_017_US_C1_TPO_Parent_Assignment#page1.tif	
source=20210909_SRM_017_US_C1_TPO_Parent_Assignment#page2.tif	

ASSIGNMENT

I, Scott Brad HERNER, residing at Lafayette, Colorado 80026, am an inventor of the subject matter described and claimed in an application for United States Letters Patent entitled "Wafer Bonding in Fabrication of 3-Dimensional NOR Memory Circuits," (hereinafter referred to as "Application") filed September 24, 2018, serial number 62/735,678, and having internal reference number of SRM-017-US V1;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I hereby assign and transfer, and hereby agree to assign and transfer, to Sunrise Memory Corporation, (hereinafter referred to as "Assignee"), a corporation organized under the laws of Delaware, with an address of 140 W. Main St., 2nd Floor, Los Gatos, California 95032, the entire right, title and interest in and to any and all inventions and improvements that are disclosed in the Application (hereinafter referred to, individually and collectively, as "Invention") and to the Application and all patents which may be granted therefrom, and all related applications (e.g., provisional applications, divisional applications, reissues, reexaminations, continuation applications, continuation-in-part applications, extensions thereof, design applications, applications in foreign countries, international applications, national phase applications, and the like). I hereby authorize and request the Commissioner of Patents and Trademarks to issue to Assignee all patents, for the Invention, or patents resulting therefrom.

I also hereby assign and transfer, and hereby agree to assign and transfer, to Assignee all right, title and interest to any and all applications for patent for the Invention throughout the world, including all rights of priority resulting from the filing of the Application or any related application, including but not limited to: the right to file applications and obtain patents, utility models, industrial models and designs for the Invention throughout the world, the right to claim priority from the Application or any related application when filing applications and obtaining patents, utility models, industrial models and designs for the Invention throughout the world.

I further agree to execute any and all powers of attorney, applications, assignments, declarations, affidavits, and any other papers in connection therewith, and generally do everything possible and necessary to perfect all rights, title and interest hereby assigned and transferred, and hereby agreed to be assigned and transferred, in and to Assignee.

Scott Brad HERNER
Scott Brad HERNER

December 18, 2018
Date

For and on behalf of Sunrise Memory Corporation

Noam Kedem
Signature

12.19.18
Date

Name: NOAM KEDAM
Title: OPERATIONS

ASSIGNMENT

I, Eli Harari, residing at Saratoga, CA 95070, am an inventor of the subject matter described and claimed in an application for United States Letters Patent entitled "Wafer Bonding in Fabrication of 3-Dimensional NOR Memory Circuits," (hereinafter referred to as "Application") filed September 24, 2018, serial number 62/735,678, and having internal reference number of SRM-017-V1 US;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I hereby assign and transfer, and hereby agree to assign and transfer, to Sunrise Memory Corporation, (hereinafter referred to as "Assignee"), a corporation organized under the laws of Delaware, with an address of 455 Los Gatos Boulevard, Los Gatos, CA 95032, the entire right, title and interest in and to any and all inventions and improvements that are disclosed in the Application (hereinafter referred to, individually and collectively, as "Invention") and to the Application and all patents which may be granted therefrom, and all related applications (e.g., provisional applications, divisional applications, reissues, reexaminations, continuation applications, continuation-in-part applications, extensions thereof, design applications, applications in foreign countries, international applications, national phase applications, and the like). I hereby authorize and request the Commissioner of Patents and Trademarks to issue to Assignee all patents, for the Invention, or patents resulting therefrom.

I also hereby assign and transfer, and hereby agree to assign and transfer, to Assignee all right, title and interest to any and all applications for patent for the Invention throughout the world, including all rights of priority resulting from the filing of the Application or any related application, including but not limited to: the right to file applications and obtain patents, utility models, industrial models and designs for the Invention throughout the world, the right to claim priority from the Application or any related application when filing applications and obtaining patents, utility models, industrial models and designs for the Invention throughout the world.

I further agree to execute any and all powers of attorney, applications, assignments, declarations, affidavits, and any other papers in connection therewith, and generally do everything possible and necessary to perfect all rights, title and interest hereby assigned and transferred, and hereby agreed to be assigned and transferred, in and to Assignee.

Eli Harari
Eli Harari

9.25.18
Date

For and on behalf of Sunrise Memory Corporation

Eli Harari
Signature

9.25.18
Date

Name: ELI HARARI
Title: CEO